G-Premio BOND TECHNIQUE GUIDE

INTRAORAL REPAIR

- Roughen surface: Rinse and dry.
- Apply Ceramic Primer II on ceramic surfaces. Dry.
- Apply G-Premio BOND to all surfaces and wait 10 sec.
- Start placing composite.
- Dry. Light cure.

HYPERSensitivity TREATMENT

- Apply G-Premio BOND. Wait 10 sec.
- Dry. Light cure.
- Remove unpolymerized layer.

BONDING PROCEDURE

- Select etching mode:
  - Self etch
  - Selective etch
  - Total etch

- Etch for 10-15 sec., rinse for 5 sec. and dry.
- Apply G-Premio BOND and wait 10 sec.
- Light curing time:
  - Light curing unit
  - Distance from light guide tip
  - High power LED (>1200 mW/cm²)
  - 5 sec.
  - 10 sec.
  - High power LED (>200 mW/cm²)
  - 5 sec.
  - 10 sec.

Prior to use, carefully read the instructions for use.
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**INTRAORAL REPAIR**
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- Rinse and dry.
- Apply Ceramic Primer II on ceramic surfaces. Dry.
- Apply G-Premio BOND to all surfaces and wait 10 sec.
- Start placing composite.
- Dry.
- Light cure.

**HYPERSENSITIVITY TREATMENT**
- Apply G-Premio BOND. Wait 10 sec.
- Dry.
- Light cure.
- Remove unpolymerized layer.

**BONDING PROCEDURE**
- Select etching mode.
- Apply G-Premio BOND and wait 10 sec.
- Start placing composite.
- Dry.
- Light cure.

**SELECT ETCHING MODE**
- Self etch
- Selective etch
- Total etch

**Light curing time**
- Distance from light guide to surface:
  - Halogen / LED (700 mW/cm²): 10 sec.
  - High power LED (>1200 mW/cm²): 5 sec.

**Prior to use, carefully read the instructions for use.**